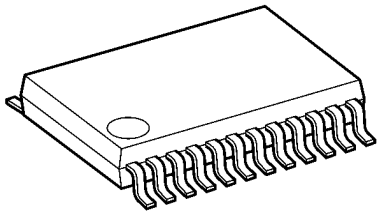
TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

TC74LVXC3245FS

Dual Supply Octal Configurable Voltage Interface Bus Transceiver



SSOP24-P-300-0.65D

Weight: 0.14 g (typ.)

The TC74LVXC3245FS is a dual supply, advanced high-speed CMOS octal configurable voltage interface bus transceiver fabricated with silicon gate CMOS technology.

Designed for use as an interface between a 3.3 V bus and a 3.3V to 5 V bus in mixed 3.3 V/5 V supply systems' it achieves high-speed operation while maintaining the CMOS low power dissipation.

It is intended for 2 way asynchronous communication between data busses.

The direction of data transmission is determined by the level of the DIR input. The enable input ($\overline{G}$) can be used to disable the device so that the buses are effectively isolated. The A-port interfaces with the 3.3-V bus, the B-port with the 3.3V to 5V bus. This device will allow the V_{CCB} voltage source pin and I/O pins on the B port to float when $\overline{G}$ is "H".

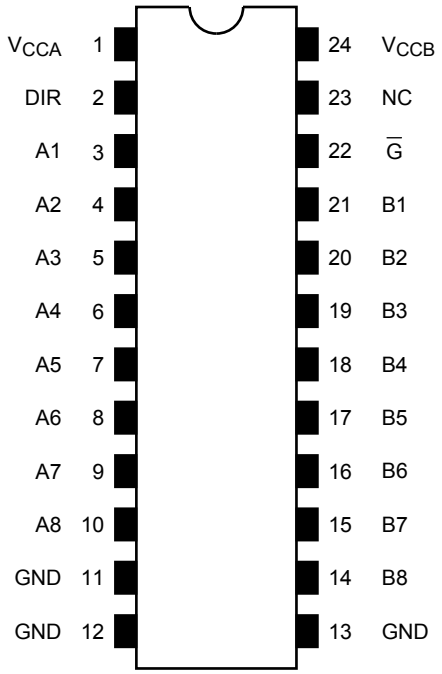
All inputs are equipped with protection circuits against static discharge or transient excess voltage.

Features

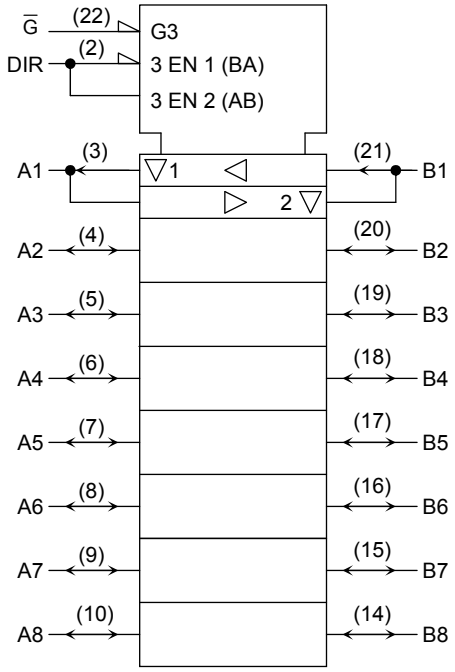
- Bi-directional interface between 3 V and 5 V buses
- High-speed: t_{pd} = 8.5 ns (max)
  (V_{CCA} = 3.3 V, V_{CCB} = 5.0 V)
- Low power dissipation: I_{CC} = 8 μA (max) (Ta = 25°C)
- Symmetrical output impedance: I_{OUTA} = ±24 mA (min)
  I_{OUTB} = ±24 mA (min)
  (V_{CCA} = V_{CCB} = 3.0 V)
- Low noise: V_{OLP} = 1.5 V (max)
- Flexible V_{CCB} operating range
- Allows B port and V_{CCB} to float simultaneously when $\overline{G}$ is "H"
- Package: SSOP (shrink small outline package)

Note: Do not apply a signal to any bus pins when it is in the output mode. Damage may result.
All floating (high impedance) bus pin must have their input levels fixed by means of pull-up or pull-down resistors.

Pin Assignment (top view)



IEC Logic Symbol



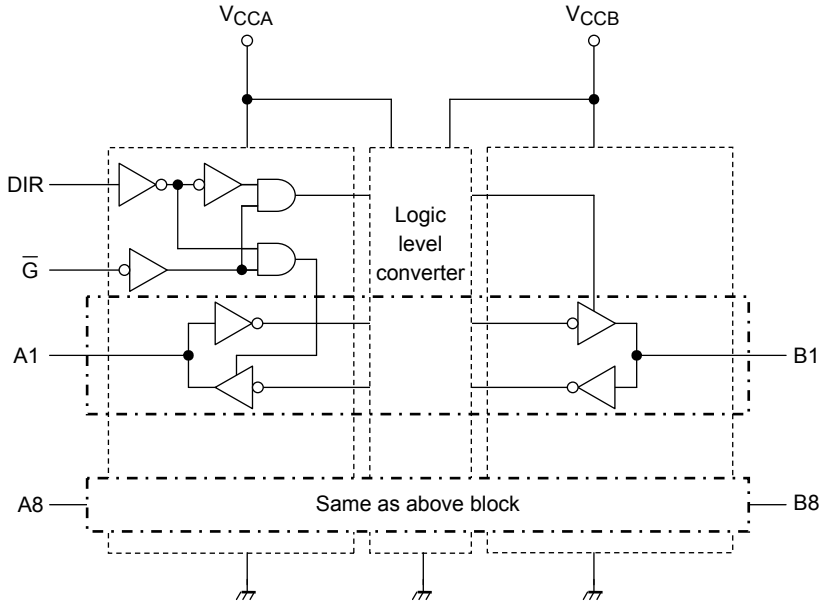
Truth Table

Inputs		Outputs	Function	
$\overline{G}$	DIR		A-Bus	B-Bus
L	L	A = B	Output	Input
L	H	B = A	Input	Output
H	X	Z	High impedance	

X: Don’t care

Z: High impedance

Block Diagram



Absolute Maximum Ratings (Note 1)

Characteristics	Symbol	Rating	Unit
Supply voltage range	V_{CCA}	−0.5 to 7.0	V
(Note 2)	V_{CCB}	−0.5 to 7.0	
DC input voltage (DIR, $\overline{G}$)	V_{IN}	−0.5 to V_{CCA} + 0.5	V
DC bus I/O voltage	$V_{I/OA}$	−0.5 to V_{CCA} + 0.5	V
	$V_{I/OB}$	−0.5 to V_{CCB} + 0.5	
Input diode current	I_{IK}	±20	mA
Output diode current	$I_{I/OK}$	±50	mA
DC output current	I_{OUTA}	±50	mA
	I_{OUTB}	±50	
DC V_{CC}/ground current	I_{CCA}	±200	mA
	I_{CCB}	±200	
Power dissipation	P_D	180	mW
Storage temperature	T_{stg}	−65 to 150	°C

Note 1: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.
Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.
Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook (“Handling Precautions”/“Derating Concept and Methods”) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 2: Don’t supply a voltage to V_{CCB} terminal when V_{CCA} is in the OFF state.

Operating Ranges (Note 1)

Characteristics	Symbol	Rating	Unit
Supply voltage range	V_{CCA}	2.7 to 3.6	V
(Note 2)	V_{CCB}	3.0 to 5.5	
Input voltage (DIR, $\overline{G}$)	V_{IN}	0 to V_{CCA}	V
Bus I/O voltage	$V_{I/OA}$	0 to V_{CCA}	V
	$V_{I/OB}$	0 to V_{CCB}	
Operating temperature	T_{opr}	−40 to 85	°C
Input rise and fall time	dt/dv	0 to 8 (V_{CCA} = 2.7 to 3.6 V)	ns/V
		0 to 8 (V_{CCB} = 3.0 to 5.5 V)	

Note1: The operating ranges are required to ensure the normal operation of the device. Unused inputs and bus inputs must be tied to either V_{CC} or GND. Please connect both bus inputs and the bus outputs with V_{CC} or GND when the I/O of the bus terminal changes by the function. In this case, please note that the output is not short-circuited.

Note2: Don't use in $V_{CCA} > V_{CCB}$.

Electrical Characteristics

DC Characteristics

Characteristics		Sym-bol	Test Condition		V_{CCA} (V)	V_{CCB} (V)	Ta = 25°C			Ta = −40 to 85°C		Unit
							Min	Typ.	Max	Min	Max	
Input voltage (V_{CCA})	H-level	V_{IHA}	DIR, $\overline{G}$, An		2.7	3.0	2.0	—	—	2.0	—	V
					3.0	3.6	2.0	—	—	2.0	—	
					3.6	5.5	2.0	—	—	2.0	—	
	L-level	V_{ILA}	DIR, $\overline{G}$, An		2.7	3.0	—	—	0.8	—	0.8	
					3.0	3.6	—	—	0.8	—	0.8	
					3.6	5.5	—	—	0.8	—	0.8	
Input voltage (V_{CCB})	H-level	V_{IHB}	Bn		2.7	3.0	2.0	—	—	2.0	—	V
					3.0	3.6	2.0	—	—	2.0	—	
					3.6	5.5	3.85	—	—	3.85	—	
	L-level	V_{ILB}	Bn		2.7	3.0	—	—	0.8	—	0.8	
					3.0	3.6	—	—	0.8	—	0.8	
					3.6	5.5	—	—	1.65	—	1.65	
Output voltage (V_{CCA})	H-level	V_{OHA}	V_{INA} = V_{IHA} or V_{ILA} V_{INB} = V_{IHB} or V_{ILB}	I_{OH} = −100 μA	3.0	3.0	2.9	3.0	—	2.9	—	V
				I_{OH} = −12 mA	3.0	3.0	2.56	—	—	2.46	—	
				I_{OH} = −24 mA	3.0	3.0	2.35	—	—	2.25	—	
				I_{OH} = −12 mA	2.7	3.0	2.3	—	—	2.2	—	
				I_{OH} = −24 mA	2.7	4.5	2.1	—	—	2.0	—	
	L-level	V_{OLA}		I_{OL} = 100 μA	3.0	3.0	—	0	0.1	—	0.1	
				I_{OL} = 24 mA	3.0	3.0	—	—	0.36	—	0.44	
				I_{OL} = 12 mA	2.7	3.0	—	—	0.36	—	0.44	
				I_{OL} = 24 mA	2.7	4.5	—	—	0.42	—	0.5	

DC Characteristics (continued)

Characteristics		Sym-bol	Test Condition		V_{CCA} (V)	V_{CCB} (V)	Ta = 25°C Min	Ta = 25°C Typ.	Ta = 25°C Max	Ta = −40 to 85°C Min	Ta = −40 to 85°C Max	Unit
Output voltage (V_{CCB})	H-level	V_{OHB}	V_{INA} = V_{IHA} or V_{ILA} V_{INB} = V_{IHB} or V_{ILB}	I_{OH} = −100 μA	3.0	3.0	2.9	3.0	—	2.9	—	V
				I_{OH} = −12 mA	3.0	3.0	2.56	—	—	2.46	—	
				I_{OH} = −24 mA	3.0	3.0	2.35	—	—	2.25	—	
				I_{OH} = −24 mA	3.0	4.5	3.86	—	—	3.76	—	
	L-level	V_{OLB}		I_{OL} = 100 μA	3.0	3.0	—	0	0.1	—	0.1	
				I_{OL} = 24 mA	3.0	3.0	—	—	0.36	—	0.44	
				I_{OL} = 24 mA	3.0	4.5	—	—	0.36	—	0.44	
3-state output Off-state current		I_{OZA}	V_{INA} = V_{IHA} or V_{ILA} V_{INB} = V_{IHB} or V_{ILB} VI/OA = V_{CCA} or GND VI/OB = V_{CCB} or GND		3.6	3.6	—	—	±0.5	—	±5.0	μA
					3.6	5.5	—	—	±0.5	—	±5.0	
		I_{OZB}			3.6	3.6	—	—	±0.5	—	±5.0	
					3.6	5.5	—	—	±0.5	—	±5.0	
Input leakage current		I_{IN}	V_{IN} (DIR, $\overline{G}$) = V_{CCA} or GND		3.6	3.6	—	—	±0.1	—	±1.0	μA
					3.6	5.5	—	—	±0.1	—	±1.0	
Quiescent supply current		I_{CCT}	PER INPUT: V_{IN} = 3.0 V		3.6	3.6	—	—	0.35	—	0.5	mA
		I_{CCA1}	An = V_{CCA} or GND Bn = Open, $\overline{G}$ = V_{CCA} DIR = V_{CCA}, V_{CCB} = Open		3.6	Open	—	—	5	—	50	μA
		I_{CCA2}	V_{INA} = V_{IHA} or V_{ILA}		3.6	3.6	—	—	5	—	50	
			V_{INB} = V_{IHB} or V_{ILB}		3.6	5.5	—	—	5	—	50	
		I_{CCB}	V_{INA} = V_{IHA} or V_{ILA}		3.6	3.6	—	—	5	—	50	
			V_{INB} = V_{IHB} or V_{ILB}		3.6	5.5	—	—	8	—	80	

AC Characteristics (input: $t_r = t_f = 3$ ns, $C_L = 50$ pF, $R_L = 500\ \Omega$, V_{CCA}=2.7 to 3.6 V)

Characteristics	Symbol	Test Condition		Ta = 25°C			Ta = −40 to 85°C		Unit
			V_{CCB} (V)	Min	Typ.	Max	Min	Max	
Propagation delay time (An → Bn)	t_{pLH}	Input: An Output: Bn (DIR = "H")	5.0 ± 0.5	—	5.7	8.0	1.0	8.5	ns
	t_{pHL}		3.3 ± 0.3	—	6.2	8.5	1.0	9.0	
3-state output enable time ($\overline{G}$ → Bn)	t_{pZL}		5.0 ± 0.5	—	6.5	9.5	1.0	10.0	ns
	t_{pZH}		3.3 ± 0.3	—	7.4	10.5	1.0	11.5	
3-state output disable time ($\overline{G}$ → Bn)	t_{pLZ}		5.0 ± 0.5	—	7.3	9.5	1.0	10.0	ns
	t_{pHZ}		3.3 ± 0.3	—	6.6	9.5	1.0	10.0	
Propagation delay time (Bn → An)	t_{pLH}	Input: Bn Output: An (DIR = "L")	5.0 ± 0.5	—	4.6	7.5	1.0	8.0	ns
	t_{pHL}		3.3 ± 0.3	—	5.2	7.5	1.0	8.0	
3-state output enable time ($\overline{G}$ → An)	t_{pZL}		5.0 ± 0.5	—	7.0	10.5	1.0	11.5	ns
	t_{pZH}		3.3 ± 0.3	—	7.0	10.5	1.0	11.5	
3-state output disable time ($\overline{G}$ → An)	t_{pLZ}		5.0 ± 0.5	—	6.1	9.5	1.0	10.0	ns
	t_{pHZ}		3.3 ± 0.3	—	6.0	9.5	1.0	10.0	
Output to output skew	t_{osLH}	(Note 1)	5.0 ± 0.5	—	—	1.5	—	1.5	ns
	t_{osHL}		3.3 ± 0.3	—	—	1.5	—	1.5	
Input capacitance	C_{INA}	DIR, $\overline{G}$	5.0 ± 0.5	—	5	10	—	10	pF
Bus input capacitance	$C_{I/O}$	An, Bn		—	8	—	—	—	
Power dissipation capacitance (Note 2)	C_{PDA}	A → B (DIR = "H")	5.0 ± 0.5	—	4	—	—	—	pF
		B → A (DIR = "L")		—	38	—	—	—	
	C_{PDB}	A → B (DIR = "H")	5.0 ± 0.5	—	88	—	—	—	
		B → A(DIR = "L")		—	7	—	—	—	

Note 1: Parameter guaranteed by design.
($t_{osLH} = |t_{pLHm} - t_{pLHn}|$, $t_{osHL} = |t_{pHLm} - t_{pHLn}|$)

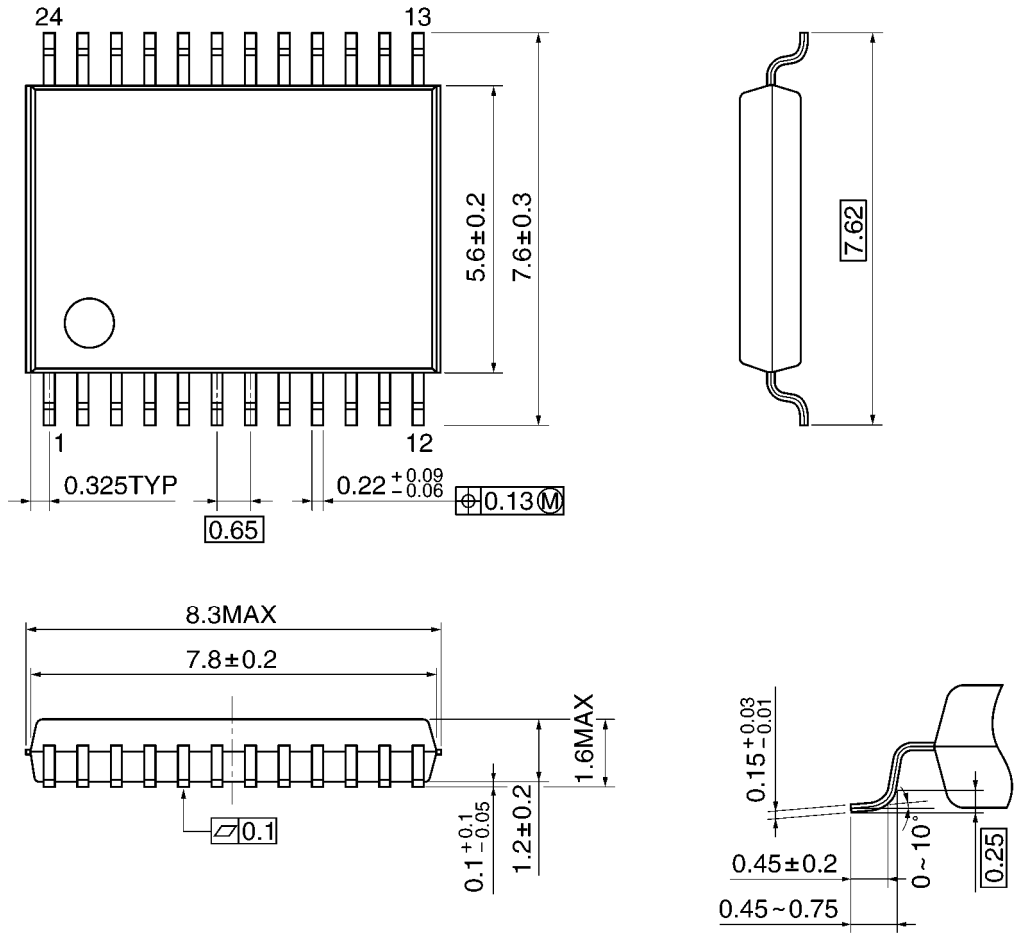
Note 2: C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.
Average operating current can be obtained by the equation:
$I_{CC\ (opr)} = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC} / 8$ (per bit)

Noise Characteristics (Ta = 25°C, input: $t_r = t_f = 3$ ns, $C_L = 50$ pF, $R_L = 500\ \Omega$)

Characteristics		Symbol	Test Condition	V_{CCA} (V)	V_{CCB} (V)	Typ.	Limit	Unit
Quiet output maximum dynamic	V_{OL} (A)	V_{OLPA}	Input: Bn Output: An (DIR = "L")	3.3	3.3	—	0.9	V
				3.3	5.0	—	0.9	
Quiet output mimimum dynamic	V_{OL} (A)	V_{OLVA}		3.3	3.3	—	−0.9	
				3.3	5.0	—	−0.9	
Quiet output maximum dynamic	V_{OL} (B)	V_{OLPB}	Input: An Output: Bn (DIR = "H")	3.3	3.3	—	0.8	
				3.3	5.0	—	1.5	
Quiet output mimimum dynamic	V_{OL} (B)	V_{OLVB}		3.3	3.3	—	−0.8	
				3.3	5.0	—	−1.2	
Minimum high level dynamic input voltage	V_{IH} (A)	V_{IHDA}	Input: An	3.3	3.3	—	2.0	V
				3.3	5.0	—	2.0	
Maximum low level dynamic input Voltage	V_{IL} (A)	V_{ILDA}	Input: An	3.3	3.3	—	0.8	V
				3.3	5.0	—	0.8	
Minimum high level dynamic input voltage	V_{IH} (B)	V_{IHDB}	Input: Bn	3.3	3.3	2.0	—	V
				3.3	5.0	3.5	—	
Maximum low level dynamic input voltage	V_{IL} (B)	V_{ILDB}	Input: Bn	3.3	3.3	0.8	—	V
				3.3	5.0	1.5	—	

Package Dimensions

SSOP24-P-300-0.65D Unit: mm



Weight: 0.14 g (typ.)

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